

#### DESCRIPTION

The MOC306x Series are optically coupled isolators consisting of a Gallium Arsenide infrared emitting diode coupled with a monolithic silicon detector performing the functions of a zero crossing bilateral triac mounted in a standard 6 pin dual-in-line package.

#### **FEATURES**

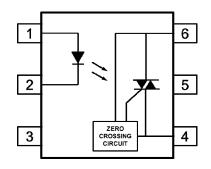
- Zero Voltage Crossing
- Triac Driver Output
- High V<sub>DRM</sub> minimum 600V
- High Critical Rate of Rise of Off-State Voltage dv/dt minimum 600V/µs
- Isolation Voltage 5000V<sub>RMS</sub>
- **RoHS Compliant**
- UL File No. E91231 Package System "TT"
- VDE File No. 40028086

#### **APPLICATIONS**

- Solenoid / Valve Controls
- **Light Controls**
- **AC Motor Drivers**
- **Temperature Controls**
- **AC Motor Starters**
- Solid State Relays

#### ORDER INFORMATION

- Add Suffix "X" for VDE Approval
- Add G after PN for 10mm lead spacing
- Add SM after PN for Surface Mount
- Add SMT&R after PN for Surface Mount Tape & Reel





- Anode
- Cathode
- 3 NC
- Main Terminal 1
- 5 Substrate, (Do not Connect)
- Main Terminal 2

#### ABSOLUTE MAXIMUM RATINGS

 $T_A = 25^{\circ}C$  unless otherwise specified.

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device.

Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

#### Input

Forward Current	50mA
Reverse Voltage	6V
Juntion Temperature	125°C
Power dissipation	120mW

#### Output

Off State Output Terminal Voltage	600V
On State RMS Current	$100 \text{mA}_{\text{RMS}}$
Peak Repetitive Surge Current (Pulse Width 100µs, 120pps)	1.0A
Junction Temperature	125°C
Power Dissipation	150mW

#### **Total Package**

Isolation Voltage	$5000V_{RMS}$
Total Power Dissipation	250mW
Operating Temperature	-40 to 100°C
Storage Temperature	-55 to 150°C
Lead Soldering Temperature (10s)	260°C

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# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise specified)

#### **INPUT**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	$V_{\mathrm{F}}$	$I_F = 20 \text{mA}$		1.2	1.4	V
Reverse Current	$I_R$	$V_R = 6V$		0.05	10	μA

#### **OUTPUT**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Peak Off-state Current Either Direction	$I_{DRM}$	$V_{DRM} = 600V$ $I_F = 0mA$			500	nA
		Note 1				
Peak Blocking Voltage Either Direction	$V_{ m DRM}$	$I_{DRM} = 500 \text{nA}$	600			V
On-state Voltage Either Direction	$V_{TM}$	$I_{TM} = 100 \text{mA (peak)}$			3.0	V
Critical Rate of Rise of Off-state Voltage (Static dv/dt)	dv/dt	$I_F = 0 m A,$ $Vin = 240 V_{RMS}$	1000			V/µs

#### **COUPLED**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Input Trigger Current Either Direction	$I_{FT}$	$V_{TM} = 3V$ Note 2				mA
		MOC3060			30	
		MOC3061			15	
		MOC3062			10	
		MOC3063			5	
Holding Current Either Direction	$I_{H}$			400		μA



## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise specified)

#### **ZERO CROSSING CHARACTERISTICS**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Inhibit Voltage	$V_{\mathrm{INH}}$	$I_F = Rated\ I_{FT},$ MT1-MT2 Voltage above which device will not trigger		5	20	V
Leakage Current at Inhibit State	$I_{\mathrm{DRM2}}$	$I_F = Rated I_{FT},$ $V_{DRM} = 600V,$ $Off-state$			500	μА

#### **ISOLATION**

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Isolation Voltage Input-Output	$ m V_{ISO}$	RH = 40 to 60%, t = 1 min Note 3	5000			$V_{RMS}$

Note 1: Test Voltage must be applied within dv/dt rating.

Note 2 : Guaranteed to trigger at an  $I_F$  value less than or equal to max  $I_{FT}$ , recommended  $I_F$  lies between Rated  $I_{FT}$  to Absolute Max  $I_F$ .

Note 3: Measured with input leads shorted together and output leads shorted together.



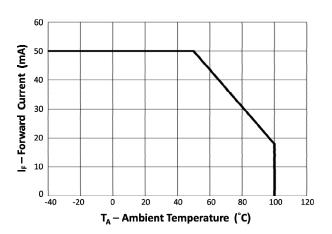


Fig 1 Forward Current vs Ambient Temperature

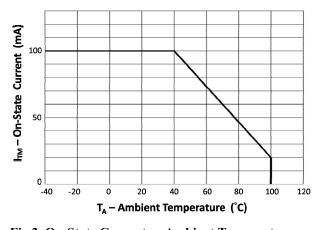


Fig 2 On-State Current vs Ambient Temperature

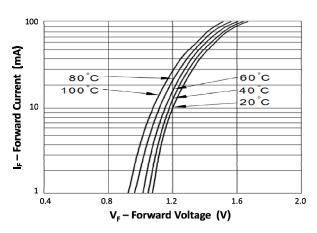


Fig 3 Forward Current vs Forward Voltage

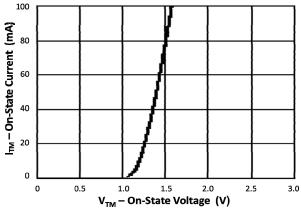


Fig 4 On-state Current vs On-State Voltage

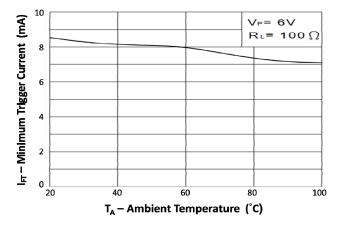


Fig 5 Minimum Trigger Current vs Ambient Temperature

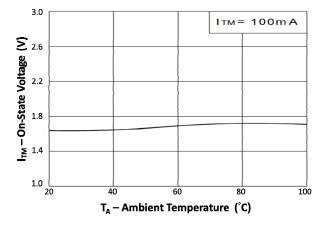


Fig 6 On-State Voltage vs Ambient Temperature



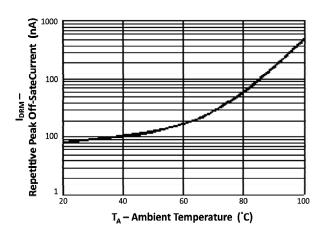


Fig 7 Repetitive Peak Off-State Current vs Ambient Temperature

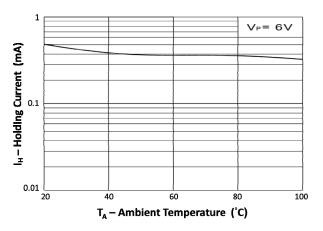


Fig 8 Holding Current vs Ambient Temperature



#### **ORDER INFORMATION**

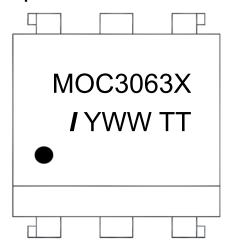
	MOC306x (UL Approval)					
After PN	PN	Description	Packing quantity			
None	MOC3060, MOC3061, MOC3062, MOC3063	Standard DIP6	65 pcs per tube			
G	MOC3060G, MOC3061G, MOC3062G, MOC3063G	10mm Lead Spacing	65 pcs per tube			
SM	MOC3060SM, MOC3061SM, MOC3062SM, MOC3063SM	Surface Mount	65 pcs per tube			
SMT&R	MOC3060SMT&R, MOC3061SMT&R, MOC3062SMT&R, MOC3063SMT&R	Surface Mount Tape & Reel	1000 pcs per reel			

	MOC306x (UL and VDE Approvals)					
After PN	PN	Description	Packing quantity			
None	MOC3060X, MOC3061X, MOC3062X, MOC3063X	Standard DIP6	65 pcs per tube			
G	MOC3060XG, MOC3061XG, MOC3062XG, MOC3063XG	10mm Lead Spacing	65 pcs per tube			
SM	MOC3060XSM, MOC3061XSM, MOC3062XSM, MOC3063XSM	Surface Mount	65 pcs per tube			
SMT&R	MOC3060XSMT&R, MOC3061XSMT&R, MOC3062XSMT&R, MOC3063XSMT&R	Surface Mount Tape & Reel	1000 pcs per reel			



#### **DEVICE MARKING**

**Example: MOC3063X** 



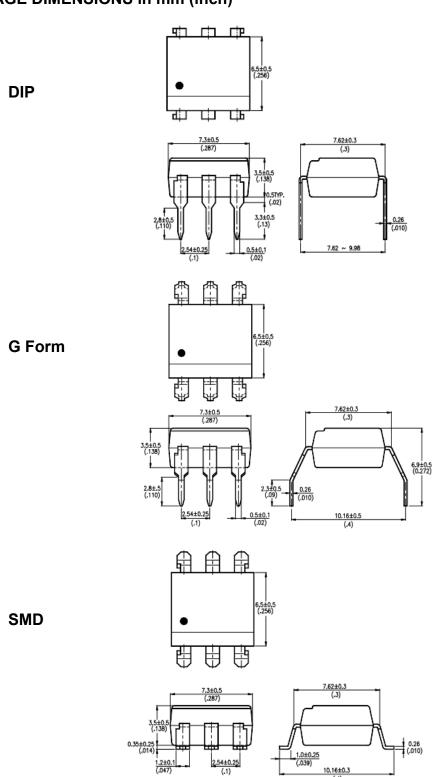
MOC3063X Denotes Device Part Number

I denotes Isocom

Y denotes 2 digit Year code
WW denotes 2 digit Week code
TT UL Package System Code

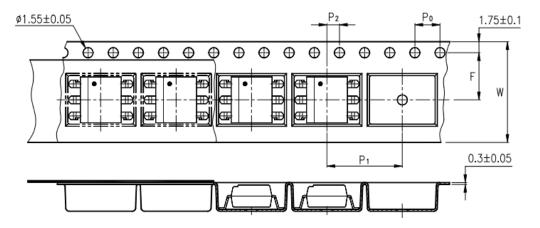


## **PACKAGE DIMENSIONS in mm (inch)**



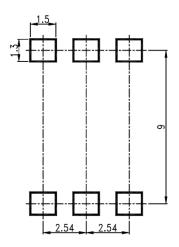


#### **TAPE AND REEL PACKAGING**



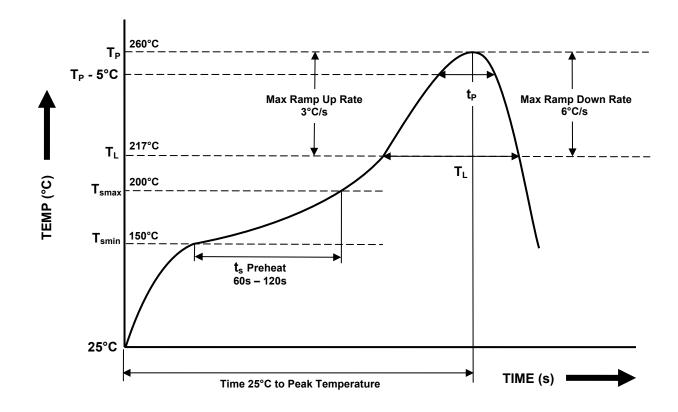
Description	Symbol	Dimension mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P <sub>0</sub>	4 ± 0.1 (0.15)
Distance of Compartment to Sprocket Holes	F	7.5 ± 0.1 (0.295)
Distance of Compartment to Sprocket Holes	P <sub>2</sub>	2 ± 0.1 (0.079)
Distance of Compartment to Compartment	P <sub>1</sub>	12 ± 0.1 (0.47)

## **RECOMMENDED PAD LAYOUT for SMD (mm)**





# IR REFLOW SOLDERING TEMPERATURE PROFILE One Time Reflow Soldering is Recommended. Do not immerse device body in solder paste.



Profile Details	Conditions
$ \begin{array}{l} \textbf{Preheat} \\ \textbf{- Min Temperature } (T_{SMIN}) \\ \textbf{- Max Temperature } (T_{SMAX}) \\ \textbf{- Time } T_{SMIN} \text{ to } T_{SMAX} \left(t_s\right) \end{array} $	150°C 200°C 60s - 120s
$\begin{tabular}{ll} \textbf{Soldering Zone} \\ - & \begin{tabular}{ll} - & \begin{tabular}{ll} \textbf{Peak Temperature} & \begin{tabular}{ll} - & \begin{tabular}{ll} \textbf{Imperature} & \begin{tabular}{ll} \textbf{Peak Temperature} & \begin{tabular}{ll} \textbf{Imperature} & \begin{tabular}{ll} Imperature$	260°C 10s max 217°C 30s max 60s - 100s 3°C/s max 6°C/s max
Average Ramp Up Rate (T <sub>smax</sub> to T <sub>P</sub> )	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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